Leon 3 Processor Delay Variability Emulator

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Modern microelectronics have increasing variations in performance, power and reliability.

Causes:

• Manufacturing:

Material properties and scaling of semiconductor devices Worsen as critical dimension shrinks to atomic scale

Modern microelectronics have increasing variations in performance, power and reliability.

Causes:

- Manufacturing
- Environment

VDD: 10% floating; Temperature: -30 °C ~ 175 °C Delay influenced by resistance and driving strength

Modern microelectronics have increasing variations in performance, power and reliability.

Causes:

- Manufacturing
- Environment
- Aging: Wear-out, performance decrease as usage time increases

The variation causes problems to both the hardware and software designer

Hardware designer

Must estimate the variation conservatively

Over design to guarantee performance

Software designer

Assumes the performance limit as labeled A waste of performance

Aim of the project

To develop a delay variability emulator for Leon 3 processor:

- Emulate variability through delay insertion
- Show the impact of delay variability on performance

- Hopefully can be used for hardware-aware software development experiments

Framework



Leon 3 processor: Basic info

- Developed by COBHAM GAISLER
- Free licensed and open source embedded processor
- Consist of multiple soft IP cores (VHDL)
- Based on SPARC architecture (not popular now)

Leon 3 processor: Architecture



Figure 202. LEON3 processor core block diagram

Configuration:

- Enable DSU and FPU
- Include separate cache
- Enable MMU (TLB)
- Enable branch prediction

Delay insertion and control



Delay element



Delay controller and General purpose register



Choosing delay insertion paths

Hardware perspective

- Post-mapping timing analysis
- Select several paths with smallest timing slack (setup time)
- Choose a signal in the path

Better for highest working clock rate

Architecture perspective

- Select a unit
- Choose a signal inside the unit

Better for delay impact in different units

Choosing delay insertion paths

Hardware perspective

Architecture perspective





Combine delay with original Leon 3 design

Constraint

• GPREG should be instantiated in top level design (uses memory bus in top level)

Methodology

- Instantiate wrapper modules (empty) for delay elements and delay controllers in top level, set as design partitions, and connect with GPREG
- Create ports in modules in each level from the top until reaching the desired insertion unit (two ports for each delay path)
- Connect specific signal with the ports, and connect ports with delay elements
- Import hard macro (logic lock region) into the design partition

Flexibility

- Manually create all the ports needed for several units at one time
- The only thing to do is to change the port connection in top level

Combine delay with original Leon 3 design



Delay scattered on the chip plan, which causes an extra base delay in the delay paths, and that may leads to a decrease in performance even if delay is disabled

Performance evaluation

GRMON: Leon 3 processor debug monitor

- Processor Info
- Load program and run
- Standard I/O
- Write/Read memory
- Trace buffer

Performance evaluation

Benchmarks (use sparc-gcc cross compiler)

- **Stanford**: A suite of benchmarks that are relatively short, both in program size and execution time. (Non-floating & Floating)
- **Dhrystone**: A synthetic computing benchmark program intended to be representative of system (integer) programming
- **Coremark**: A benchmark that aims to measure the performance of CPU used in embedded systems
- Stream: A simple synthetic benchmark program that measures sustainable memory bandwidth

Type 1: Performance impact of different delay paths on different benchmarks, when delay is inserted in memory control module



Created automated batch and python script for running benchmark 16*80*5 times and extracting results.

Error Type:

- **Illegal instruction** ('unimp' or unknown opcode)
- Memory address not aligned ('ld' and 'st', caused by incorrect instruction content)
- Data store error (write buffer error)
- Hang (output unreadable code)
- Instruction/Data access exception (Error during instruction fetch and data load)



Type 2: Performance impact of transient delay insertion, when delay is inserted in memory control module

Create a new thread in Stanford benchmark to randomly insert delay for a short period in parallel with the benchmark main thread

Connect GPREG output with LEDs to show delay value. LEDs will blink during the program runtime if the program fortunately exits normally; otherwise the LEDs will stuck at light on with a program error.



Benchmark is run 100 times for each data point

Type 3: Performance impact of delay insertion, when delay is inserted in 7-stage pipeline

Fetch stage (branch controller)

Error type: Hang for a long time, then end up with error

Execution stage

Error type: Data store error

Decode stage

Error type: Data store error

Further thoughts.. Execution time = **IC** x CPI x **CT**

Delay insertion can have influence on:

Cycle time: A high clock frequency can lead to program running incorrectly

Instruction count: Mess up the speculation units in processor to increase instruction count (branch prediction, prefetching, ..)

- Speculation units needed (Leon 3 is simple)
- Detailed program trace needed for analysis (not available in GRMON)

Conclusion

What has been done

- Implemented the delay variability emulation flow for Leon 3 processor
- Obtained and analyzed several performance experiments results

What can be done further

- Insert delay in more units
- Use a more sophisticated processor
- With more support from GRMON (may need a paid license), precise impact can be studied from detailed program trace (trace buffer only 4KB now)

Thank you